

Switching (30V, 7A)

RDS070N03

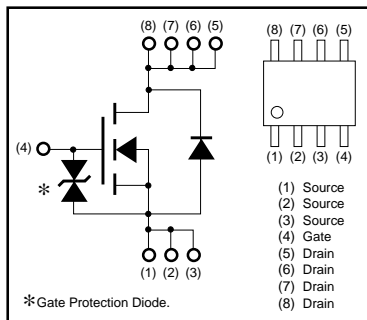
●Features

- 1) Low Qg.
- 2) Low on-resistance.
- 3) Excellent resistance to damage from static electricity.

●Structure

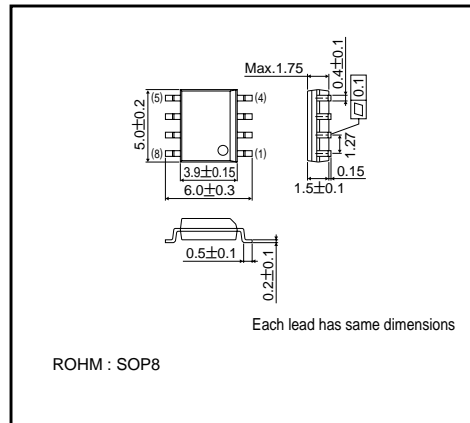
Silicon N-channel
MOS FET

●Equivalent circuit



* A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use a protection circuit when the fixed voltage are exceeded.

●External dimensions (Units : mm)



●Absolute maximum ratings (Ta = 25°C)

| Parameter | Symbol | Limits | Unit | |
|-----------------------------------|------------|-------------|------|---|
| Drain-Source Voltage | V_{DS} | 30 | V | |
| Gate-Source Voltage | V_{GS} | ± 20 | V | |
| Drain Current | Continuous | I_D | 7 | A |
| | Pulsed | I_{DP}^* | 28 | A |
| Reverse Drain Current | Continuous | I_{DR} | 7 | A |
| | Pulsed | I_{DRP}^* | 28 | A |
| Source Current (Body Diode) | Continuous | I_S | 1.6 | A |
| | Pulsed | I_{SP}^* | 6.4 | A |
| Total Power Dissipation (Tc=25°C) | P_D | 2.5 | W | |
| Channel Temperature | T_{ch} | 150 | °C | |
| Storage Temperature | T_{stg} | -55~+150 | °C | |

* $P_w \leq 10 \mu s$, Duty cycle $\leq 1\%$

Transistors

● Thermal resistance (Ta = 25°C)

| Parameter | Symbol | Limits | Unit |
|--------------------|-----------|--------|------|
| Channel to Ambient | Rth(ch-A) | 62.5 | °C/W |

● Electrical characteristics (Ta = 25°C)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
|-----------------------------------------|----------------------|------|------|------|------|--------------------------------------------|
| Gate-Source Leakage | I _{GSS} | – | – | ±10 | μA | V _{GS} =±20V, V _{DS} =0V |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | 30 | – | – | V | I _D =1mA, V _{GS} =0V |
| Zero Gate Voltage Drain Current | I _{DSS} | – | – | 10 | μA | V _{DS} =30V, V _{GS} =0V |
| Gate Threshold Voltage | V _{GS(th)} | 1.0 | – | 2.5 | V | V _{DS} =10V, I _D =1mA |
| Static Drain-Source On-State Resistance | R _{DS(on)*} | – | 23 | – | mΩ | I _D =7A, V _{GS} =10V |
| | | – | 38 | – | | I _D =7A, V _{GS} =4.5V |
| | | – | 47 | – | | I _D =7A, V _{GS} =4.0V |
| Forward Transfer Admittance | I _{Yfs} I* | 5 | – | – | S | I _D =7A, V _{DS} =10V |
| Input Capacitance | C _{iss} | – | 470 | – | pF | V _{DS} =10V |
| Output Capacitance | C _{oss} | – | 260 | – | pF | V _{GS} =0V |
| Reverse Transfer Capacitance | C _{rss} | – | 105 | – | pF | f=1MHz |
| Turn-On Delay Time | t _{d(on)*} | – | 10 | – | ns | I _D =3.5A, V _{DD} =15V |
| Rise Time | t _r * | – | 14 | – | ns | V _{GS} =10V |
| Turn-Off Delay Time | t _{d(off)*} | – | 35 | – | ns | R _L =4.3Ω |
| Fall Time | t _f * | – | 12 | – | ns | R _{GS} =10Ω |
| Total Gate Charge | Q _g * | – | 14 | 28 | nC | V _{DD} =15V |
| Gate-Source Charge | Q _{gs} * | – | 2 | – | nC | V _{GS} =10V |
| Gate-Drain Charge | Q _{gd} * | – | 4 | – | nC | I _D =7A |

*Pulsed

● Body diode characteristics (Source-Drain characteristics) (Ta = 25°C)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
|-------------------------|-------------------|------|------|------|------|--------------------------------------------|
| Forward Voltage | V _{SD} * | – | – | 1.5 | V | I _S =6.4A, V _{GS} =0V |
| Reverse Recovery Time | t _{rr} * | – | 46 | – | ns | I _{DR} =5.2A, V _{GS} =0V |
| Reverse Recovery Charge | Q _{rr} * | – | 46 | – | nC | di/dt=100A/μs |

*Pulsed

Transistors

● Electrical characteristic curves

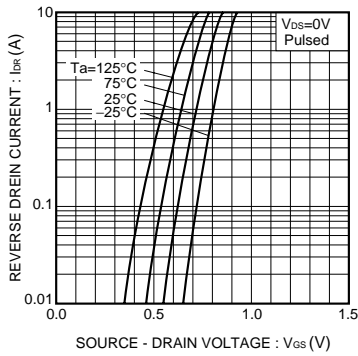


Fig.1 Reverse Drain Current vs. Source-Drain Voltage

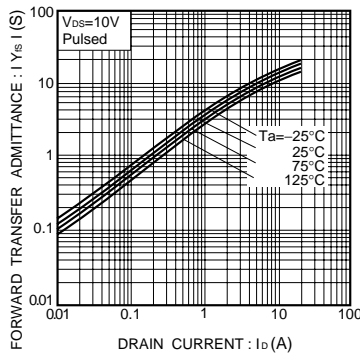


Fig.2 Forward Transfer Admittance vs. Drain Current

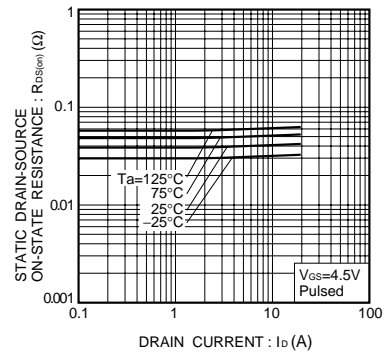


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current (I)

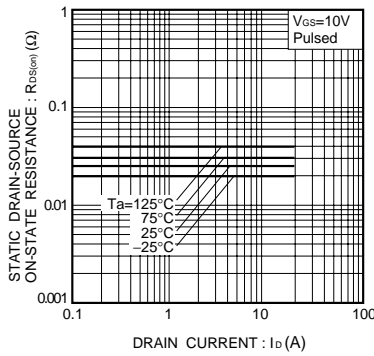


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (II)

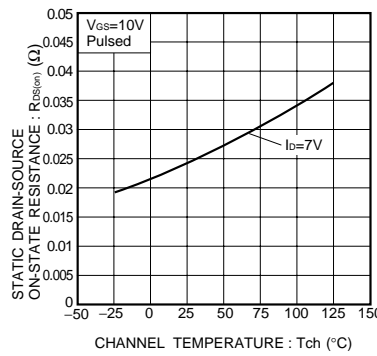


Fig.5 Static Drain-Source On-State Resistance vs. Channel Temperature

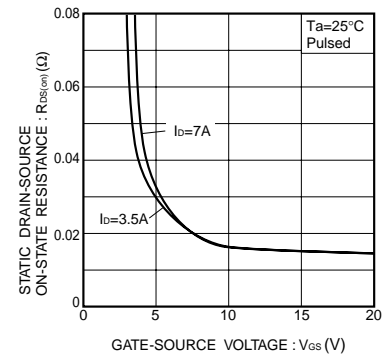


Fig.6 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

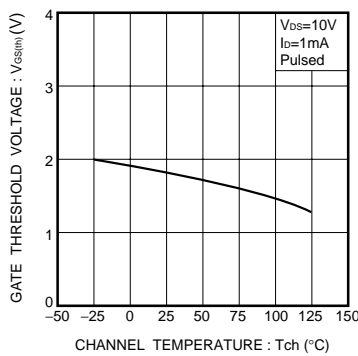


Fig.7 Gate Threshold Voltage vs. Channel Temperature

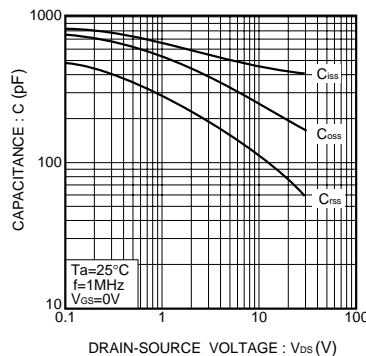


Fig.8 Typical Capacitance vs. Drain-Source Voltage

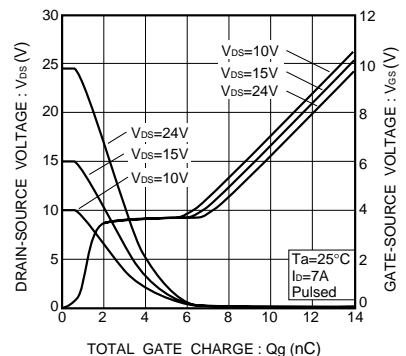


Fig.9 Dynamic Input Characteristics

Transistors

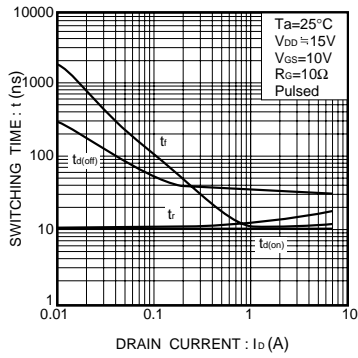


Fig.10 Switching Characteristics

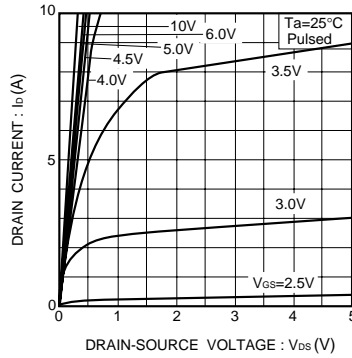


Fig.11 Typical Output Characteristics

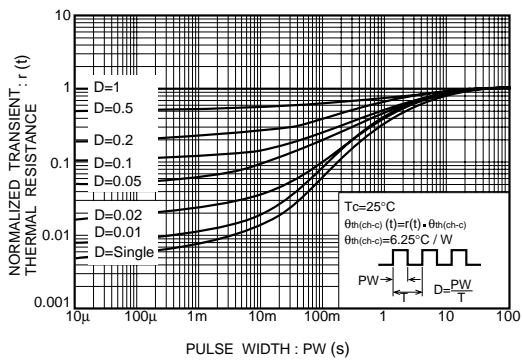


Fig.12 Normalized Transient Thermal Resistance vs. Pulse Width